H.J. Willy

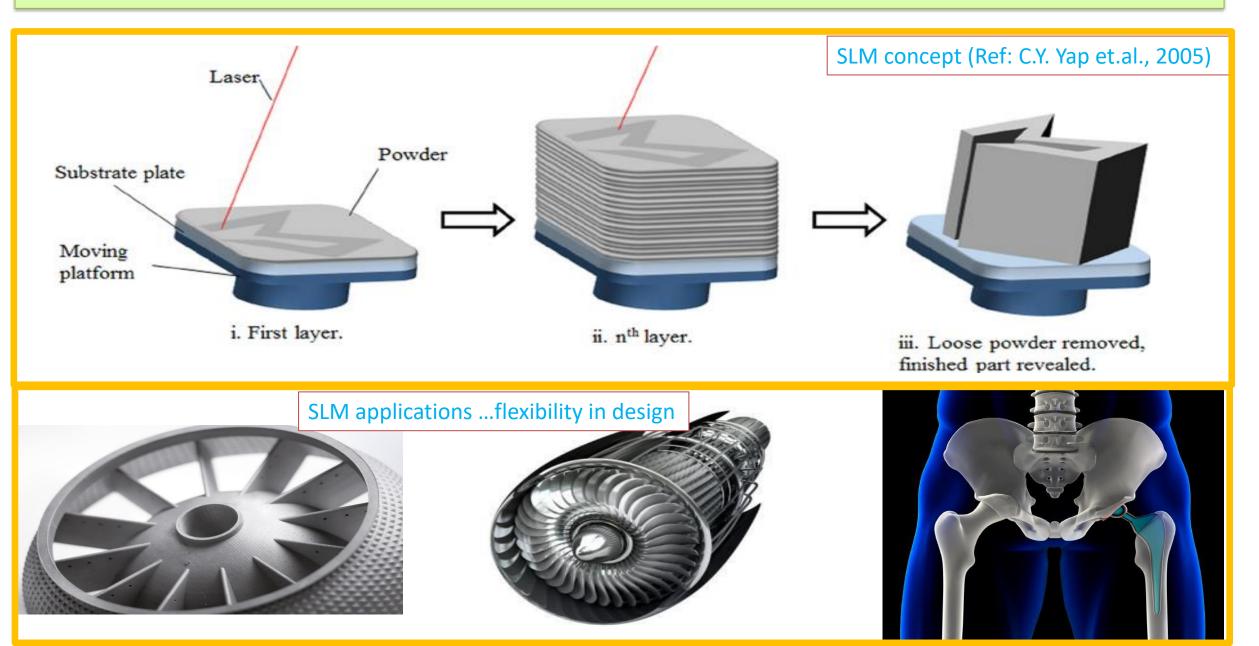
Materials Science and Engineering, Faculty of Engineering, National University of Singapore



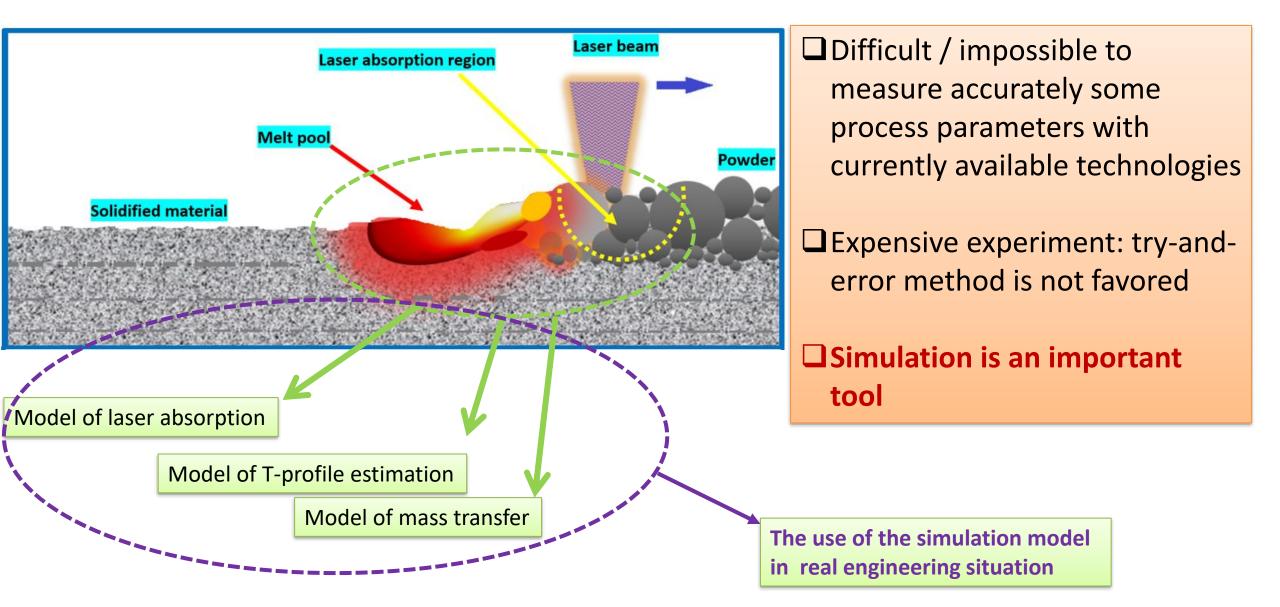


Finite elements modelling and simulation tools to investigate Selective Laser Melting process and materials 3Dprinted.

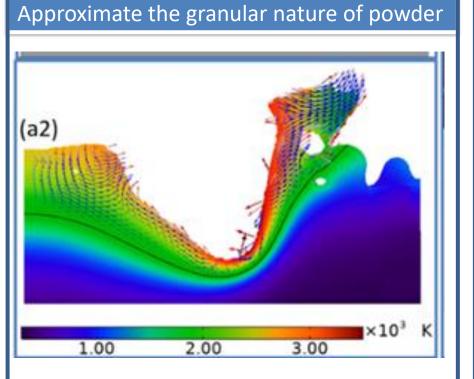
Introduction to SLM process



Introduction to SLM process



Introduction: Different levels of approximation

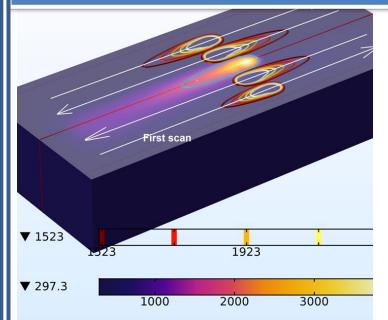


- High computation cost/time
- Differ from real powder bed
- Particular case
- Good for studying porosity or roughness of printed parts

Deformed geometry-moving mesh

- High computation cost/time
- Generalized study
- Good for studying roughness of printed parts

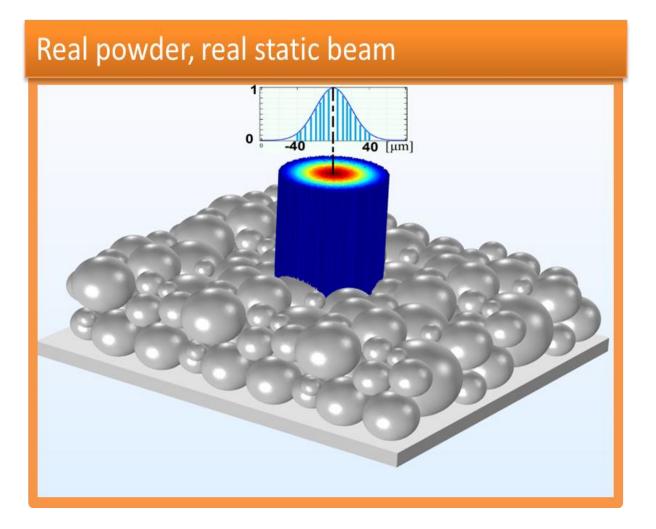
Indirect modelling of volume shrinkage and mass transfer without geometry change



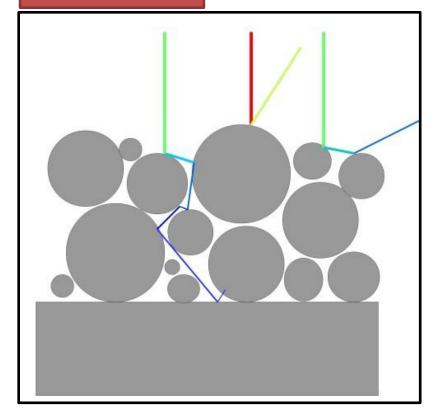
- Low computation cost/time
- Generalized printing quality
- Melt pool size, cooling curve, scanning patterns, multiple layers...
- Adjust the size of powder layer and printed layer

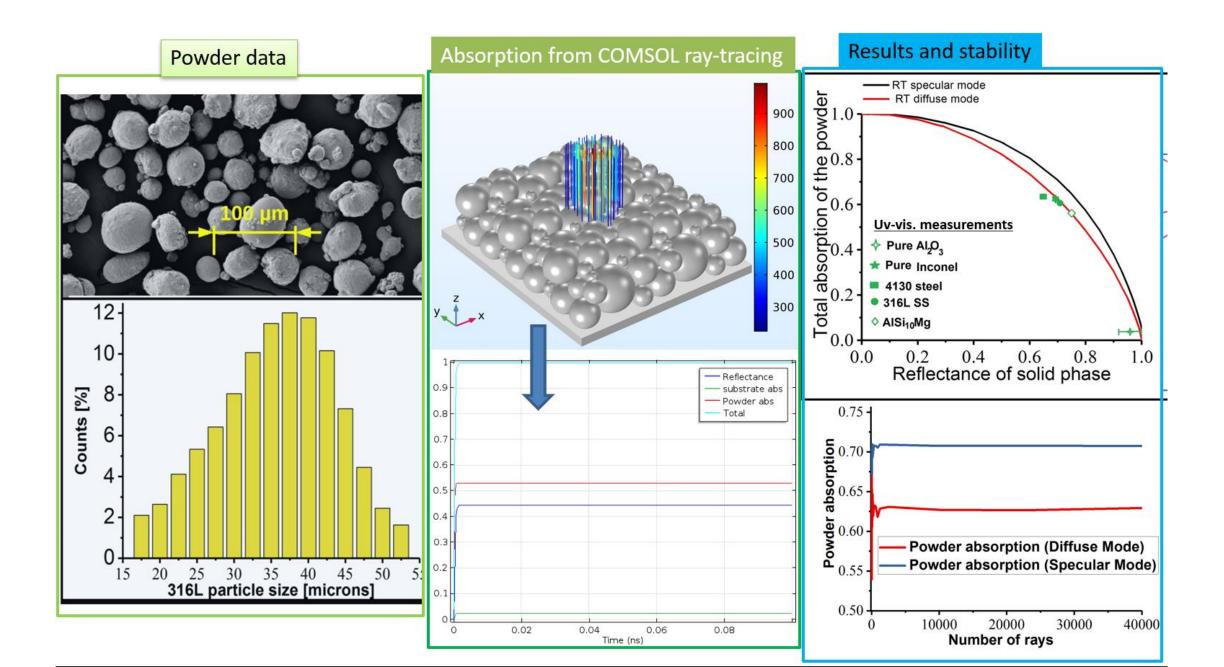
Simulated temperature-profile is comparable in the 3 approximations

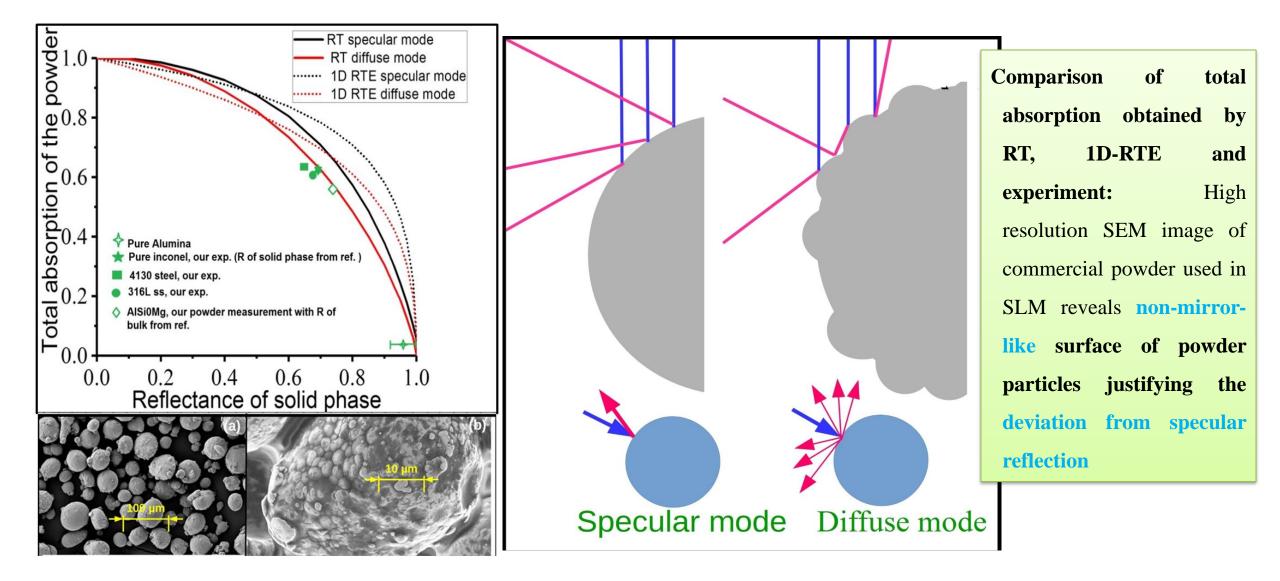
1. Laser absorption: Ray-tracing



Illustration

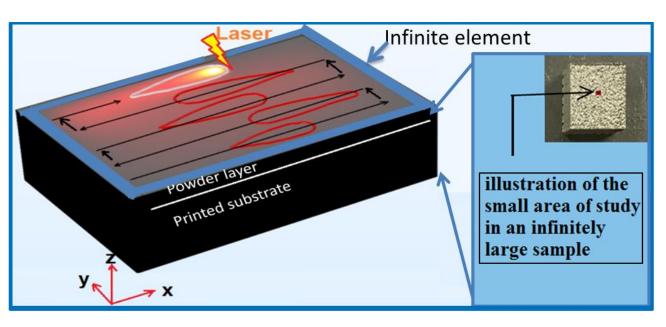






2. Model of T-profile estimation

 $\rho c_p \frac{\partial T}{\partial t} + \rho c_p u. \nabla T - \nabla (k \nabla T) = Q$ **Heat transfer** $k \left[\frac{\partial T}{\partial z} \right]_{z=H} = \varepsilon \sigma \left(T_o^4 - T^4(x, y, H, t) \right) + h(T_o - T(x, y, H, t))$ $T(x, y, z, t)|_{t=0} = T_0$ **Mass transfer** $\begin{cases} \rho \frac{\partial u}{\partial t} + \rho(u, \nabla)u = \nabla \left[-PI + \mu \left((\nabla u + (\nabla u)^T) \right) \right] + \rho g + F \end{cases}$ $\rho \nabla .\left(u\right) =0.$ Laser energy source from Ray-tracing and distribution $\mathbf{Q} = (\alpha_{A})_{\pi 1 (\alpha_{r} r)^{2}} \exp \left\{ \frac{2[(x-p_{1}(t))^{2}+(y-p_{2}(t))^{2}]}{(\alpha_{r} r)^{2}} \right\}$ $\times \mathbf{u}(\mathbf{z})$ From Ray-tracing $F^{Marangoni} = \nabla_{S}\gamma$, $\gamma = \gamma_{0} + \frac{d\gamma}{dT}(T - T_{ref})$ **Recoil pressure during vaporization**

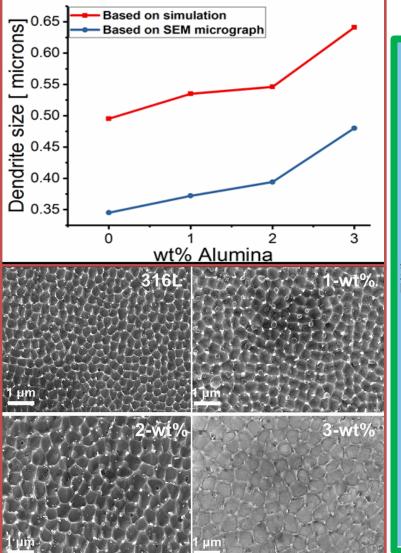


Note: Immediate coupling of ray-tracing

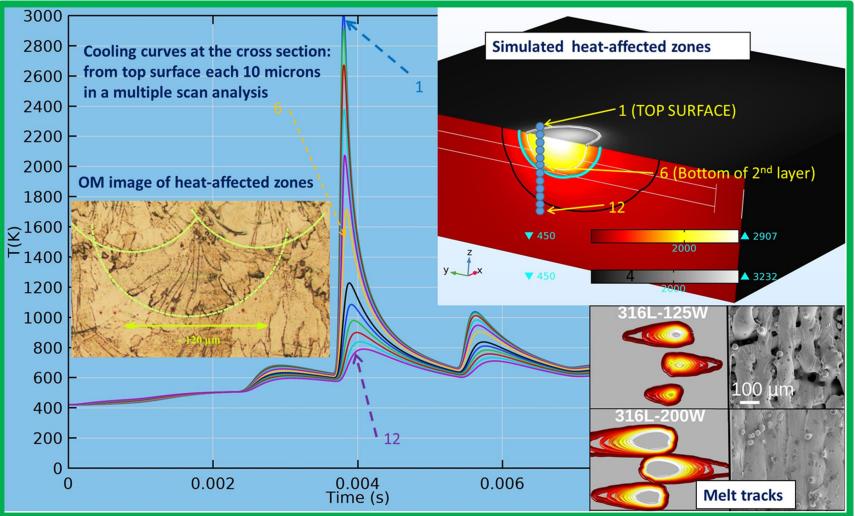
3. COMSOL setting

Component (compa)		_	950 -
Definitions			
A Geometry 1	Data set: Study 1/Solul ▼		900 -
Materials	Time selection: All		850 -
Heat Transfer in Solids (ht)			850 -
🔺 🏣 Heat Transfer in Solids 1	▷ Title		800
Translational Motion 1	- Dist Settings		
🎦 Initial Values 1	 Plot Settings 		750 -
Thermal Insulation 1	x-axis label: Time (s)		700
Convection			
👂 🗖 Diffuse Surface 1	y-axis label: 🗹 T(oC)		650
🕨 📄 Heat Transfer with Phase Change in bulk	Two y-axes		
E Laser volume source	Flip the x- and y-axes	ΰ	600
🔚 Temperature 1		T(oC)	550
尿 Symmetry 1	 Axis 		550
Heat Transfer with Phase Change in powder	Manual axis limits		500
E Temperature 2			
Laminar Flow (spf)	x minimum: -1.22263E-4		450
I dit Domain ODEs and DAEs (dode)	x maximum: 0.00776		400
Multiphysics	y minimum: 131.59997		
🗅 🛕 Meshes			350
∿≫ Study 1	y maximum: 1016.23428		300
Results			300
Data Sets	Preserve aspect ratio		250
▷ 🕁 Views	x-axis log scale		
8.85 e-12 Derived Values	y-axis log scale		200 -
🖻 🧮 Tables			150 -
▷ 🛅 Temperature (ht)	▼ Grid		
Velocity field	Show grid		0 0.001 0.002 0.003 0.004 0.00
$ ho \sim 1$ D Plot Group 8_ depth			Time (s)
> ~ 1D Plot Group 9_Top_ scanning lines	Manual spacing	A de	essages × Progress Log Evaluation 3D ×
1D Plot Group 9_ substrate_lines	x spacing: 1	INIE	essages × Progress Log Evaluation 3D ×
$ ightarrow \sim$ 1D Plot Group 9_ substrate_lines 1		6	
▷ 🝼 U_comparison	y spacing: 1	CON	MSOL Multiphysics 5.4.0.388

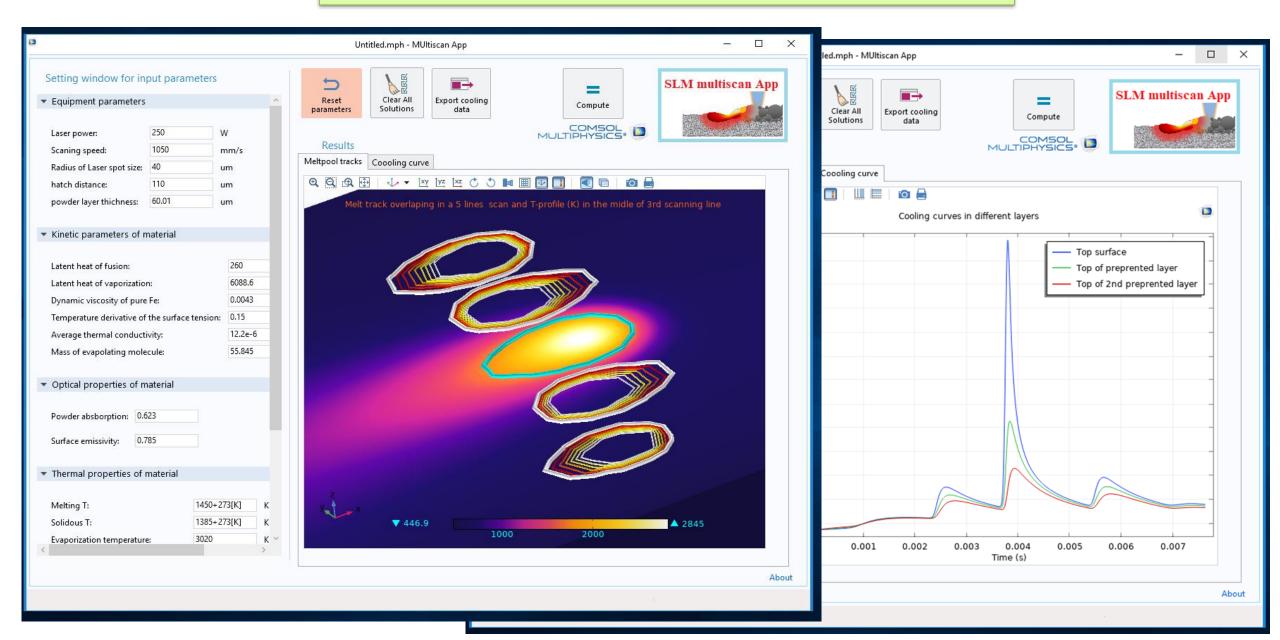
316L-Alumina composite: control of grain size



3. Some examples using SLM simulation



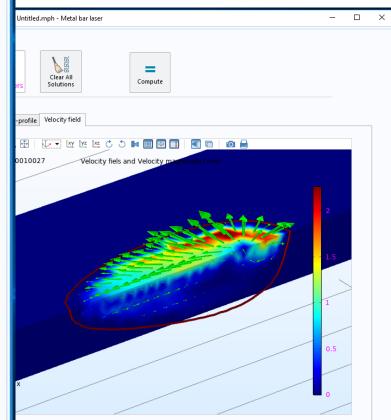
4. COMSOL App – Multiple scanning lines



COMSOL App – Single scan

arameters setting wind	ow				
 Equipment parameters 		^	Reset Clear All		
			parameters Solutions Compute		
Scaning speed:	750.01 mm	/s	Results		
Radius of the laser spot size:	0.040 mm	6	Melt pool and T-profile Velocity field		
Laser power:	75.01 W				
Powder layer thichness:	50 um		Q Q 19 🐼 🗸 • 🖄 🖄 🖉 C 🔿 🛤 🥅 🐼 🚺 🔞 🖻 🔒		
			Time=0.0010027 Temperature proble (k) and melt pool		
 Optical properties of materi 	al		×10	3	
Surface emissivity: 0.43			XIO		
			4.	8 e .	
Total powder absorption: 0.63					
 Thermal properties of mater 	iak				
merma properties of mater	1013			5	
Melting Temperature:	1450+273[K]	к			
Solidous Temperature:	1380+273 [K]	к	-3		
Evaporization temperature:	3020	к	25	e	
Latent heat of fusion:	260	J/g			
Latent heat of vaporization:	6088.6	J/kg	2		
Mass of evapolating molecule:	55.845	u			
Thermal conductivity of solid p	hase: 13.4	W/(m	1.5		
Thermal conductivity of solid p	hase: 31.1	W/(m	1		
Density of solid phase:	7950	kg/m ¹			
	7311	kg/m ¹			
Density of liquid phase:					

Note: Melt pool size usually increases a bit from 1 to 2nd line due to heat accumulation but it normally stabilizes at the 3rd line. One should know this while using this single scan model



Summary

• Compared to experimental measurements of laser absorption in commercial powders used in SLM, ray-tracing diffuse mode gives the best approximation.

• The results of T-profile simulation (overlapping of molten truck, molten pool size, cooling information) agree with experiment .

• SLM being a relatively complex process, COMSOL Apps is useful for users without strong background in modelling.